Smart Systems (SmaSys2019&2020)

Guest Editors:

Prof. Dr. Hidemitsu Furukawa

Prof. Dr. Bungo Ochiai

Dr. Masato Makino

Dr. Ajit Khosla

Deadline for manuscript submissions:
closed (31 July 2021)

Message from the Guest Editors

Dear Colleagues,

We are planning to publish a Special Issue on "Smart Systems" related to the International Conference of Smart Systems Engineering (SmaSys2019&2020). The Special Issue on "Smart Systems" provides opportunities for collaboration across a wide range of fields and technologies related to emerging smart systems. Smart systems regard broad scientific and engineering fields. They include organic materials, organic electronics, organic devices, biomaterials, biomedical and biosystem engineering, electrical engineering and informatics, mechanical systems engineering, smart flexible structure and systems, green materials and their processing, tourism engineering with agriculture and foods, and new engineering education.

All the participants of SmaSys2019&2020 and their colleagues, especially their students, are encouraged to submit their works to this Special Issue.

Prof. Dr. Hidemitsu Furukawa
Prof. Dr. Bungo Ochiai
Dr. Masato Makino
Dr. Ajit Khosla
Guest Editors

Special Issue

Editor-in-Chief

Prof. Dr. Manoj Gupta
Materials Group, Department of
Mechanical Engineering, National
University of Singapore, 9
Engineering Drive 1, Singapore
117576, Singapore

Message from the Editor-in-Chief

Technologies, provides a single focus for reporting on developments of all technologies, regardless of their application. It is our intention that *Technologies* becomes the journal of choice for both researchers wanting to publish their work and technologists wishing to exploit the high quality research across a wide range of potential applications. Through its open access policy, its quick publication cycle, *Technologies* will facilitate the rapid uptake and development of the research presented, ultimately providing benefit to the wider society.

Author Benefits

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.
High Visibility: indexed within ESCI (Web of Science), Scopus, Inspec, INSPIRE, and other databases.
Journal Rank: CiteScore - Q1 (*Computer Science (miscellaneous)*)

Contact Us